

## ITL Part Code - CU16



## **Specification**

Material: OFHC Copper

Oxygen free high conductivity (OFHC) copper is a suitable sealing material for bakeable UHV systems because of its good conformity with the thermal expansion coefficient of stainless steel as well as its essentially lower hardness (approx. 85 Brinell).

| For Flange OD | D1        | D2        | Pack size |
|---------------|-----------|-----------|-----------|
| 34 (1.33)     | 21 (0.83) | 16 (0.63) | 10        |

